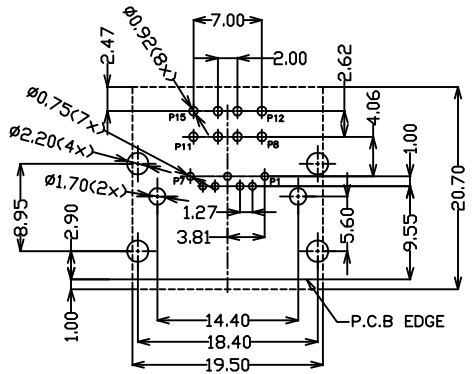
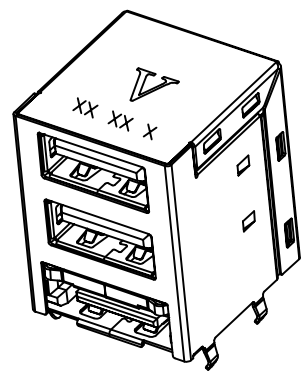
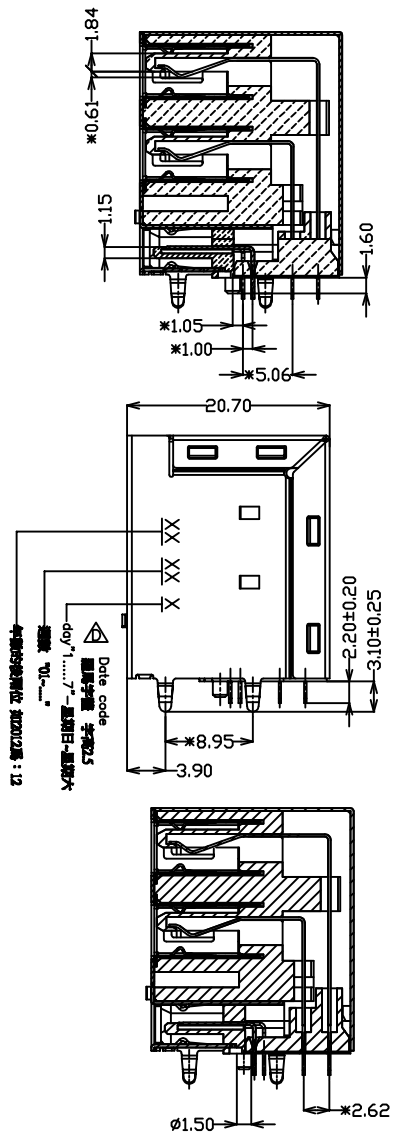
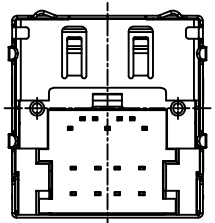
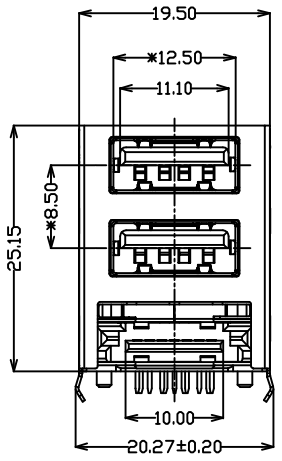
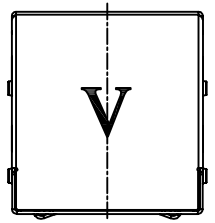


1 2 3 4 5 6 7

A
B
C
D
E

A
B
C
D
E



PCB LAYOUT(TOP VIEW)±0.05

- NOTES:
 1. MATERIALS
 1.1. USB Terminal: Copper alloy(C2680).
 ESATA Terminal: Copper alloy(C2680)
 1.2. USB Housing : PBT+30% G.F., UL 94V-0
 ESATA Housing : SEE PART NO., UL 94V-0
 Cover : SEE PART NO., UL 94V-0.
 2. PLATING:
 2.1. USB Terminal: contact area: G/F over Ni 50u',
 solder area: Sn 100u' over Ni 50u'
 ESATA Terminal: contact area: Au over Ni 50u',
 solder area: Sn 100u' over Ni 50u'.

- SPECIFICATION:
 1. Contact Current Rating: 1 AMPS.
 2. Insulation Resistance: 5000M Ohm MIN. AT 500V DC
 3. Dielectric Withstanding Volt: AC 250V(R.M.S)/1 minute
 4. Operation Temperature: -55° - +85°
 ROHS compliant

PART NO.	Housing Material	COLOR
	20065-T1	USB: PBT+30%G/F ESATA: NY46+30%G/F

DIMENSIONS TOLERANCE

METRIC
.0= ±.38
.00= ±.25
.000= ±.15
.0000= ±
ANG.= ±2°

尚益科技有限公司 JMSCONN TECHNOLOGY CO., LED.					
PROJ	SCALE : F DO NOT SCALE DWG	MOLD NO 20065-T1			
APP		MODEL	FILE NO	REV. X1	
CHK					
DGN		UNIT	SHT 1 OF 1	SIZE A4	
DRW	HSIEH	2016.11.16	MM		

1 2 3 4 5 6 7